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Table of Contents

Message from the Workshop Chairs	v
Workshop Organization	vi

Session 1

Automated Continual Learning of Defect Identification in Coherent Diffraction Imaging	1
<i>Orcun Yildiz (Argonne National Laboratory, USA), Henry Chan (Argonne National Laboratory, USA), Krishnan Raghavan (Argonne National Laboratory, USA), William Judge (Formerly of University of Illinois Chicago, USA), Mathew J. Cherukara (Argonne National Laboratory, USA), Prasanna Balaprakash (Argonne National Laboratory, USA), Subramanian Sankaranarayanan (Argonne National Laboratory, USA), and Tom Peterka (Argonne National Laboratory, USA)</i>	
A Case Study on Coupling OpenFOAM with Different Machine Learning Frameworks	7
<i>Fabian Orland (RWTH Aachen University, Germany), Kim Sebastian Brose (RWTH Aachen University, Germany), Julian Bissantz (Technical University Darmstadt, Germany), Federica Ferraro (Technical University Darmstadt, Germany), Christian Terboven (RWTH Aachen University, Germany), and Christian Hasse (Technical University Darmstadt, Germany)</i>	
PhySRNet: Physics Informed Super-Resolution Network for Application in Computational Solid Mechanics	13
<i>Rajat Arora (Senior Member of Technical Staff, USA)</i>	
Determining HEDP Foams' Quality with Multi-View Deep Learning Classification	19
<i>Nadav Schneider (SNRC, Israel; IAEC, Israel), Matan Rusanovsky (NRCN, Israel), Raz Gvishi (SNRC, Israel), and Gal Oren (Technion, Israel; NRCN, Israel)</i>	

Session 2

Pattern-Based Autotuning of OpenMP Loops using Graph Neural Networks	26
<i>Akash Dutta (Iowa State University, USA), Jordi Alcaraz (University of Oregon, USA), Ali TehraniJamsaz (Iowa State University, USA), Anna Sikora (Universitat Autònoma de Barcelona, Spain), Eduardo Cesar (Universitat Autònoma de Barcelona, Spain), and Ali Jannesari (Iowa State University, USA)</i>	
Ensuring AI For Science Is Science: Making Randomness Portable	32
<i>Hana Ahmed (Sandia National Laboratories, USA), Roselyne Tchoua (DePaul University, USA), and Jay Lofstead (Sandia National Laboratories, USA)</i>	
Practical Federated Learning Infrastructure for Privacy-Preserving Scientific Computing	38
<i>Lesi Wang (University of Nevada, United States) and Dongfang Zhao (University of Nevada, United States)</i>	
Scalable Integration of Computational Physics Simulations with Machine Learning	44
<i>Mathew Boyer (DoD HPCMP PET / GDIT, USA), Wesley Brewer (DoD HPCMP PET / GDIT, USA), Dylan Jude (US Army Combat Capabilities Development Command, Aviation & Missile Center, USA), and Ian Dettwiller (US Army Engineer Research & Development Center, USA)</i>	
Author Index	51